

# swissbit®

## Product Fact Sheet

### Industrial mSATA SSD (M0-300 Full Size)

### X-75m Series

SATA Gen3 – 6.0 Gbit/s, 3D TLC

Commercial and Industrial  
Temperature Grade

Date: September 05, 2022  
Revision: 1.04



# Product Fact Sheet

## X-75m Series



### Product Summary

- **Capacities:** 30 GBytes, 60 GBytes, 120 GBytes, 240 GBytes, 480 GBytes, 960 GBytes
- **Form Factor<sup>1</sup>:** JEDEC MO-300 Full Size mSATA SSD (50.8 mm x 29.85 mm x 3.8 mm)
- **Compliance:** SATA Gen3 – 6 Gbit/s (Gen2 – 3 Gbit/s and Gen1 – 1.5 Gbit/s backward compatible)
- **Command Sets:** Supports ATA/ATAPI-8 and ACS-2
- **Performance:**
  - Read Performance: Sequential Read up to 565 MBytes/s, Random Read 4K up to 73,600 IOPS
  - Write Performance: Sequential Write up to 495 MBytes/s, Random Write 4K up to 79,400 IOPS
- **Operating Temperature Range<sup>2</sup>:**
  - Commercial: 0 °C to 70 °C / Industrial: -40 °C to 85 °C
- **Storage Temperature Range:** -40 °C to 85 °C
- **Operating Voltage:** 3.3 V ± 5%
- **Power (Max):** Read (Active): 2.4 W; Write (Active): 3.0 W; Idle: 395 mW; Partial: 100 mW
- **Data Retention:** 10 Years @ Life Begin; 1 Year @ Life End
- **Endurance in TeraBytes Written (TBW) @ Max Capacity<sup>3</sup>:** Sequential WL ≥ 3,240; Client WL ≥ 310; Enterprise WL ≥ 770
- **Shock/Vibration:** 1,500 g / 50 g
- **LDPC ECC** with up to 165 bit correction per 1 KByte page
- **NAND Flash Technology:** Triple-Level Cell (TLC) 3D NAND Flash
- **Mean Time Between Failure:** > 2,000,000 hours
- **Data Reliability:** < 1 non-recoverable error per 10<sup>16</sup> bits read

### Product Features

- Dynamic and Static Wear Leveling
- Active and Passive Data Care Management
- Lifetime Enhancements
  - Dynamic Bad Block Remapping
  - Write Amplification Reduction
- On-Board Power Fail Protection
- TRIM and NCQ Support
- ATA Security Feature Set Support
- DEVSLP Compatible
- In-Field Firmware Update
- Enterprise-Grade Self-Monitoring, Analysis, and Reporting Technology (S.M.A.R.T.)
- 30 µinch Gold-Plated Connector (IPC-6012B Class 2 Compliant)
- End-to-End (E2E) Data Protection
- AES256 Encryption (on request)
- TCG OPAL 2.0 Compliant (on request)
- Swissbit Life Time Monitoring (SBLTM) Tool and SDK for SBLTM (on request)

### Why Swissbit?

Swissbit is focused on the design, development, manufacture, and support of leading edge memory and storage solutions for the worldwide OEM/ODM marketplace. As a global supplier, Swissbit recognizes and addresses the higher level of application requirements of today's industrial, Netcom, and automotive customers by providing best-in-class products and services, with uncompromised attention to driving overall value and quality.

<sup>1</sup> The verification of the host system and storage device compatibility is the customer's responsibility. Swissbit can provide guidance and support upon request.

<sup>2</sup> Adequate airflow is required to ensure the temperature, as reported in the S.M.A.R.T. data, does not exceed 110°C (industrial temperature drive) and 95°C (commercial temperature drive) respectively.

<sup>3</sup> According to JEDEC (JESD471), the time to write the full TBW is a minimum of 18 months. Higher average daily data volume reduces the specified TBW. The values listed are estimates and are subject to change without notice.